



3NM60

Preliminary

Power MOSFET

3.0A, 600V N-CHANNEL SUPER-JUNCTION MOSFET

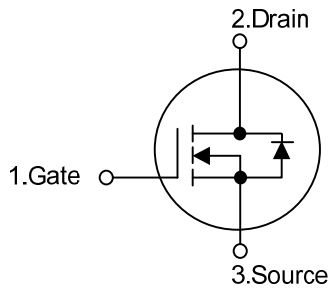
DESCRIPTION

The **UTC 3NM60** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

FEATURES

- * $R_{DS(ON)} < 1.86\Omega @ V_{GS} = 10V, I_D = 1.5A$
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

SYMBOL

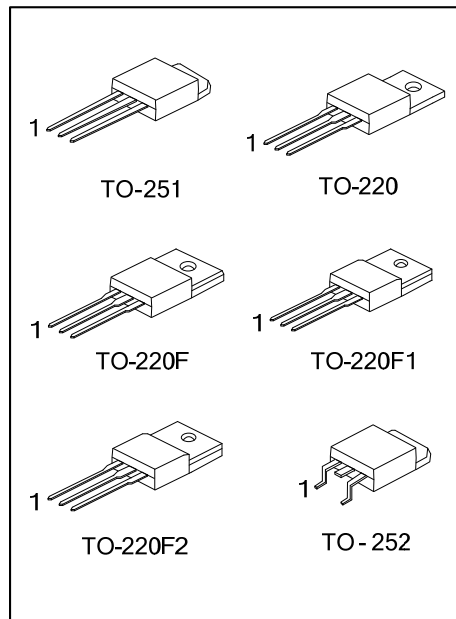


ORDERING INFORMATION

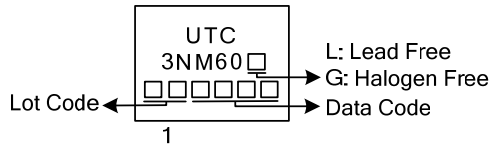
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
3NM60L-TA3-T	3NM60G-TA3-T	TO-220	G	D	S	Tube
3NM60L-TF1-T	3NM60G-TF1-T	TO-220F1	G	D	S	Tube
3NM60L-TF2-T	3NM60G-TF2-T	TO-220F2	G	D	S	Tube
3NM60L-TF3-T	3NM60G-TF3-T	TO-220F	G	D	S	Tube
3NM60L-TM3-T	3NM60G-TM3-T	TO-251	G	D	S	Tube
3NM60L-TN3-R	3NM60G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>3NM60L-TA3-T</p> <p>(1) Packing Type</p> <p>(2) Package Type</p> <p>(3) Green Package</p>	<p>(1) T: Tube, R: Tape Reel</p> <p>(2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TM3: TO-251, TN3: TO-252</p> <p>(3) L: Lead Free, G: Halogen Free and Lead Free</p>
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■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	600	V
Gate-Source Voltage		V_{GSS}	± 30	V
Continuous Drain Current		I_D	3.0	A
Pulsed Drain Current (Note 2)		I_{DM}	12	A
Avalanche Current (Note 2)		I_{AR}	1.2	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	104	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	5.0	V/ns
Power Dissipation	TO-220	P_D	75	W
	TO-220F/TO-220F1		34	W
	TO-220F2		35	W
	TO-251/TO-252		50	W
Junction Temperature		T_J	+150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3. $L=144\text{mH}$, $I_{AS}=1.2\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\ \Omega$, Starting $T_J = 25^\circ\text{C}$

4. $I_{SD}\leq 3.0\text{A}$, $di/dt\leq 200\text{A}/\mu\text{s}$, $V_{DD}\leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F	θ_{JA}	62.5	$^\circ\text{C}/\text{W}$
	TO-220F1/TO-220F2			
	TO-251/TO-252			
Junction to Case	TO-220	θ_{JC}	1.67	$^\circ\text{C}/\text{W}$
	TO-220F/TO-220F1		3.68	
	TO-220F2		3.58	
	TO-251/TO-252		2.5	

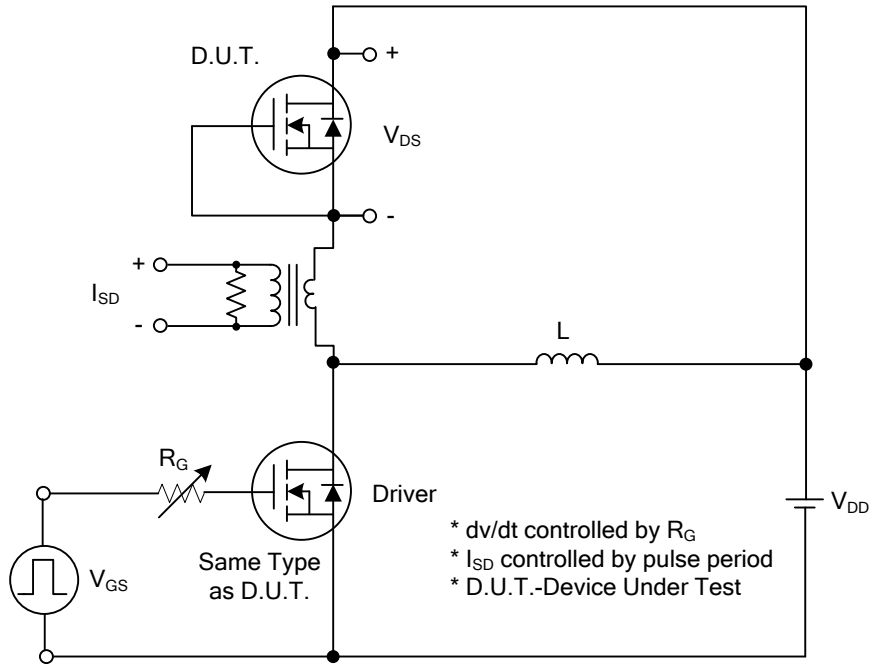
■ ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0\text{ V}, I_D=250\mu\text{A}$	600			V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=600\text{ V}, V_{GS}=0\text{V}$			10	μA
Gate-Source Leakage Current	Forward	$V_{GS}=+30\text{ V}, V_{DS}=0\text{V}$ $V_{GS}=-30\text{ V}, V_{DS}=0\text{V}$			+100	nA
	Reverse				-100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2.5		4.5	V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10\text{V}, I_D=1.5\text{A}$			1.86	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{ISS}	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1\text{MHz}$		222		pF
Output Capacitance	C_{OSS}			148		pF
Reverse Transfer Capacitance	C_{RSS}			15		pF
SWITCHING CHARACTERISTICS						
Total Gate Charge (Note 1)	Q_G	$V_{DS}=50\text{V}, V_{GS}=10\text{V}, I_D=1.3\text{A},$ $I_G=100\mu\text{A}$ (Note 1, 2)		30		nC
Gate to Source Charge	Q_{GS}			3.6		nC
Gate to Drain Charge	Q_{GD}			6.4		nC
Turn-ON Delay Time (Note 1)	$t_{D(ON)}$	$V_{DD}=30\text{V}, V_{GS}=10\text{V}, I_D=0.5\text{A},$ $R_G=25\Omega$ (Note 1, 2)		38		ns
Rise Time	t_R			45		ns
Turn-OFF Delay Time	$t_{D(OFF)}$			90		ns
Fall-Time	t_F			31		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current	I_S				3.0	A
Maximum Body-Diode Pulsed Current	I_{SM}				8.0	A
Drain-Source Diode Forward Voltage (Note 1)	V_{SD}	$I_S=3.0\text{ A}, V_{GS}=0\text{ V}$			1.4	V
Body Diode Reverse Recovery Time (Note 1)	t_{rr}	$I_S=3.0\text{ A}, V_{GS}=0\text{ V}$ $dI_F/dt=100\text{A}/\mu\text{s}$		210		ns
Body Diode Reverse Recovery Charge	Q_{rr}			1.4		μC

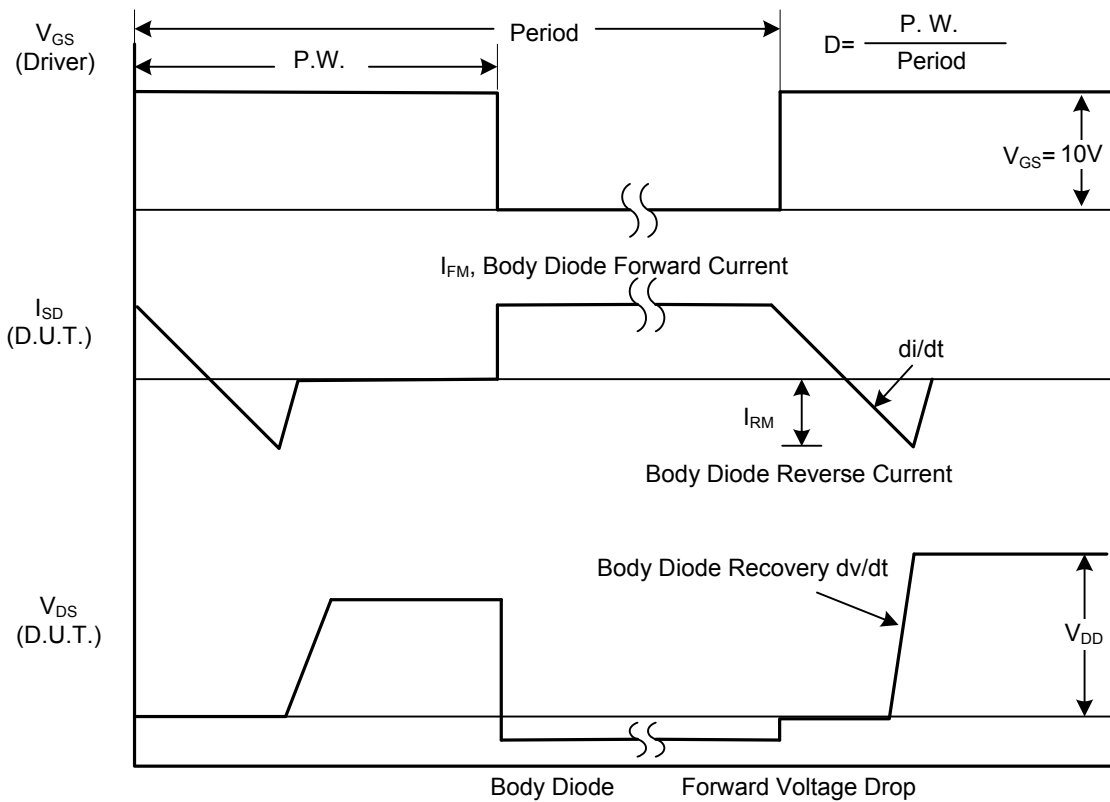
Notes: 1. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

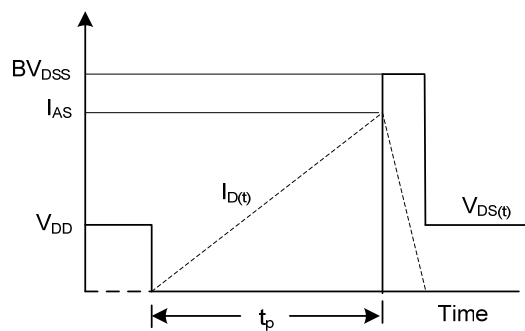
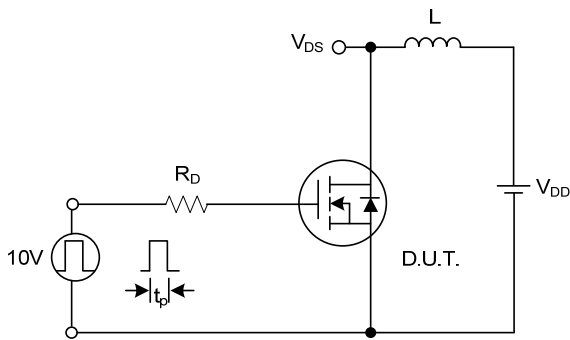
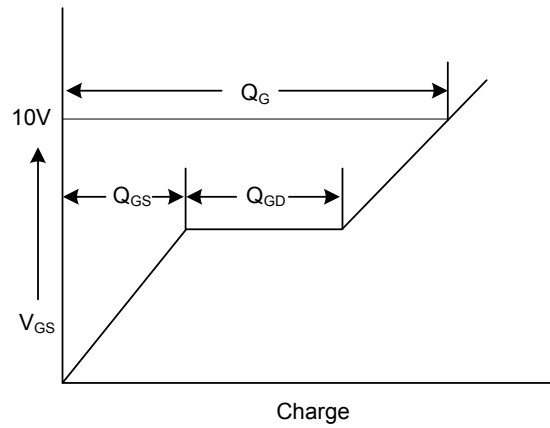
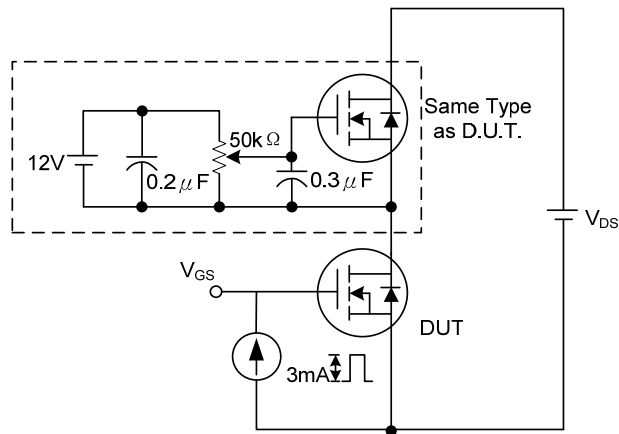
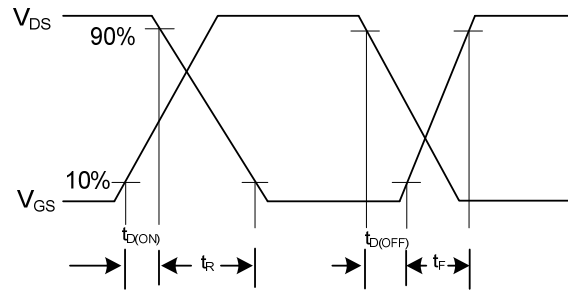
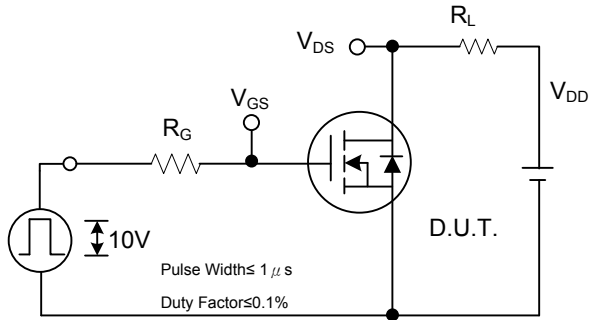


Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS (Cont.)



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